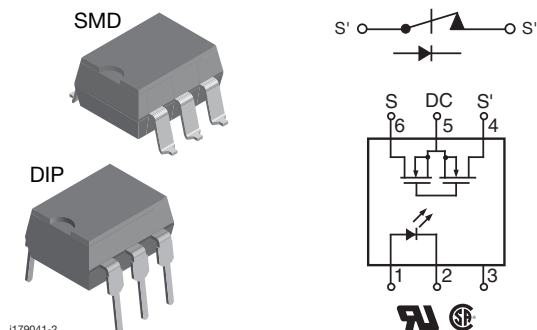


1 Form B Solid State Relay



DESCRIPTION

The LH1511 relays are SPST normally closed switches (1 form B) that can replace electromechanical relays in many applications. The relays are constructed as a multi-chip hybrid device. Actuation control is via an infrared LED. The output switch is a combination of a photodiode array with MOSFET switches and control circuitry. The relays can be configured for AC/DC or DC only operation.

FEATURES

- Isolation test voltage 3750 V_{RMS}
- Typical R_{ON} 10 Ω
- Load voltage 200 V
- Clean bounce free switching
- Low power consumption
- SMD lead available on tape and reel
- Compliant of RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC



RoHS
COMPLIANT

APPLICATIONS

- General telecom switching
- Security equipment
- Instrumentation
- Industrial controls

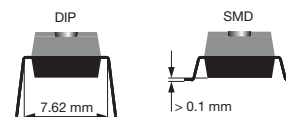
AGENCY APPROVALS

UL1577: file no. E52744

CSA: certification 093751

ORDERING INFORMATION

L	H	1	5	1	1	B	#	#	T	R
PART NUMBER						ELECTR. VARIATION	PACKAGE CONFIG.		TAPE AND REEL	



PACKAGE	UL, CSA
SMD-6, gullwing, tubes	LH1511BAB
SMD-6, gullwing, tape and reel	LH1511BABTR
DIP-6, tubes	LH1511BT

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
LED continuous forward current		I _F	50	mA
LED reverse voltage	I _R ≤ 10 μA	V _R	8	V
OUTPUT				
DC or peak AC load voltage	I _L ≤ 50 μA	V _L	200	V
Continuous DC load current - bidirectional		I _L	200	mA
Continuous DC load current - unidirectional		I _L	300	mA
Peak load current (single shot)	t = 100 ms	I _p	400	mA
SSR				
Ambient temperature range		T _{amb}	- 40 to + 85	°C
Storage temperature range		T _{stg}	- 40 to + 125	°C
Pin soldering temperature ⁽¹⁾	t = 10 s max.	T _{sld}	260	°C
Input to output isolation voltage	t = 1 s, I _{ISO} = 10 μA max.	V _{ISO}	3750	V _{RMS}
Output power dissipation (continuous)		P _{diss}	550	mW

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

⁽¹⁾ Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

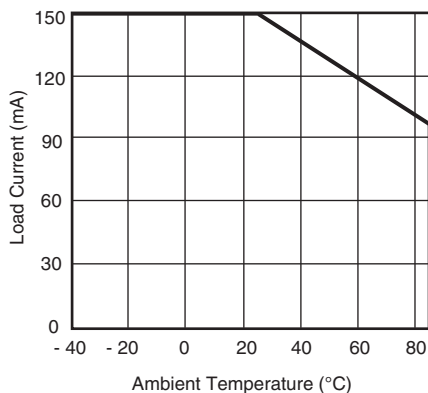
ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
LED forward current, switch turn-on	$I_L = \pm 200\text{ mA}$, $t = 10\text{ ms}$	I_{Fon}	0.2	0.9		mA
LED forward current, switch turn-off	$V_L = \pm 150\text{ V}$	I_{Foff}		1	2	mA
LED forward voltage	$I_F = 10\text{ mA}$	V_F	1.15	1.26	1.45	V
OUTPUT						
On-resistance, AC/DC: pin 4, 6 (+) to 5 (-)	$I_F = 0\text{ mA}$, $I_L = 50\text{ mA}$	R_{ON}		10	15	Ω
On-resistance, DC: pin 4, 6 (+) to 5 (-)	$I_F = 0\text{ mA}$, $I_L = 100\text{ mA}$	R_{ON}		2.5	3.75	Ω
Off-resistance	$I_F = 5\text{ mA}$, $V_L = \pm 100\text{ V}$	R_{OFF}	0.1	1.4		$G\Omega$
Off-state leakage current	$I_F = 5\text{ mA}$, $V_L = \pm 200\text{ V}$	I_O		0.07	1	μA
Output capacitance	$I_F = 5\text{ mA}$, $V_L = 50\text{ V}$	C_O		50		pF
TRANSFER						
Capacitance (input to output)	$V_{ISO} = 1\text{ V}$	C_{IO}		3		pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_F = 10\text{ mA}$, $I_L = 50\text{ mA}$	t_{on}		1.2	3	ms
Turn-off time	$I_F = 10\text{ mA}$, $I_L = 50\text{ mA}$	t_{off}		1	3	ms

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)



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Fig. 1 - Recommended Operating Conditions

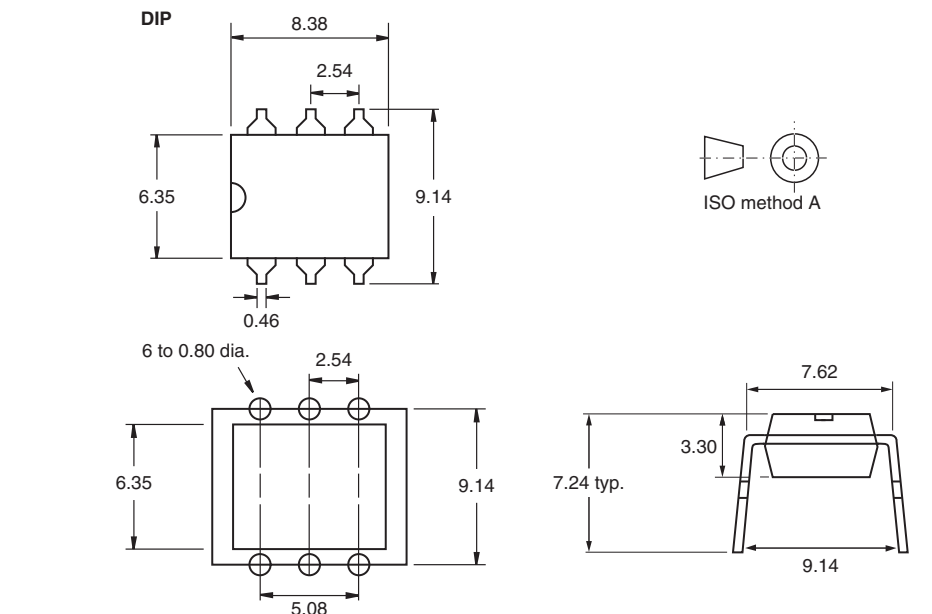


LH1511BAB, LH1511BABTR, LH1511BT

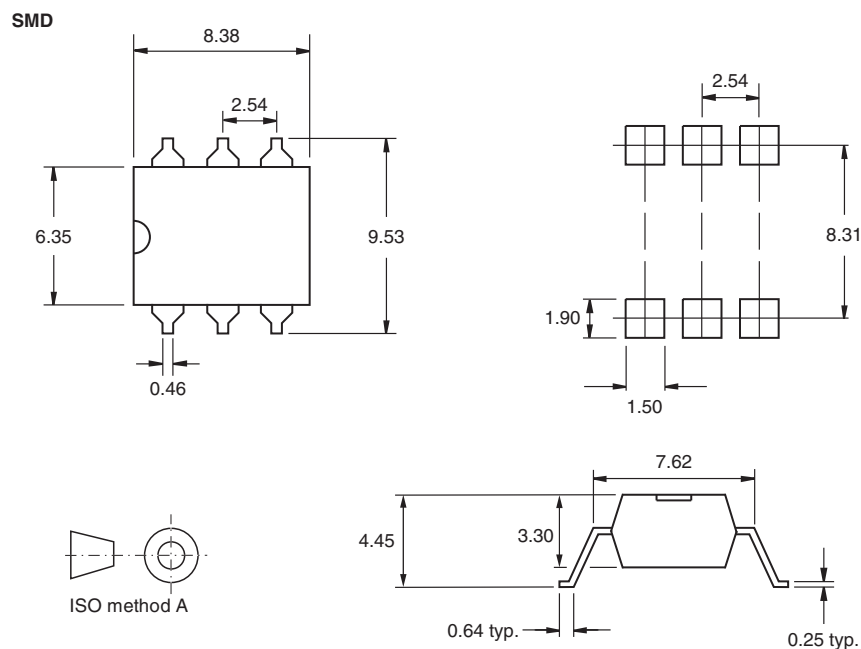
1 Form B Solid State Relay

Vishay Semiconductors

PACKAGE DIMENSIONS in millimeters

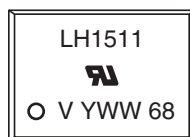


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i178016-1

PACKAGE MARKING (example)



Note

- Tape and reel suffix (TR) is not part of the package marking.



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